

Intern Programme Application Form

Important information

This form relates to the Intern Programme at MC. Please download and fill in the required details. When completed, please email this form as an attachment, along with the additional documents, to Jess Tuhega at recruitment@mc.co.nz. If you have any questions please contact Jess.

Full Legal Name: _____ Date: _____
Given Last

Preferred name: _____ Preferred pronoun: _____

Address: _____

Phone: _____ Email: _____

Preferred location: Auckland Wellington

What ethnicity/ethnicities do you identify with? (optional) _____

Ethnicity data is used to track the reach and response to MC's Intern Programme offer. You don't have to provide this information if you don't want to.

Which of the following applies to you:

New Zealand Citizen Permanent Resident Valid Visa with conditions allowing work

Please state the type of visa if applicable _____

How did you find out about this programme?

MC Website University Email or Intranet MC Social Media Accounts MC Referral Other

If you selected other, please explain _____

If you have been referred, please state by who _____

Education

Qualification: _____ Year: Penultimate Final

Current Overall GPA: _____ Current GPA for Law Degree: _____

We are ideally seeking candidates with a GPA of 6 or higher. If this is not the case, please outline in your cover letter what qualities, skills and experiences you could bring to MC / the role.

Additional Documents

For this application we require the following additional documents:

1 - CV 2 - Academic Transcript 3 - Cover letter

What you include in your cover letter is up to you, but we recommend you include the following information:

- Why do you want to work at MC
- Any notable special achievements
- What do you believe you can bring to the role
- Community involvement

Disclaimer and Signature

I certify that my answers, and additional documents, are true and complete to the best of my knowledge. If this application leads to employment, I understand that false or misleading information in my application may result in my release.

Signature: _____ Date: _____